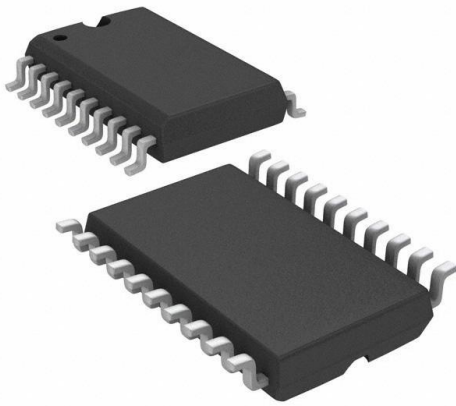


# ADS7809U/1K Datasheet

[www.digi-electronics.com](http://www.digi-electronics.com)



ADS7809U/1K

<https://www.DiGi-Electronics.com>

|                              |  |
|------------------------------|--|
| DiGi Electronics Part Number | ADS7809U/1K-DG   |
| Manufacturer                 | <a href="#">Texas Instruments</a>                        |
| Manufacturer Product Number  | ADS7809U/1K  |
| Description                  | IC ADC 16BIT SAR 20SOIC                                  |
| Detailed Description         | 16 Bit Analog to Digital Converter 1 Input 1 SAR 20-SOIC |



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

Manufacturer Product Number:

ADS7809U/1K

Series:

-

Number of Bits:

16

Number of Inputs:

1

Data Interface:

SPI, DSP

Ratio - S/H:ADC:

1:1

Architecture:

SAR

Voltage - Supply, Analog:

5V

Features:

-

Package / Case:

20-SOIC (0.295", 7.50mm Width)

Mounting Type:

Surface Mount

Manufacturer:

Texas Instruments

Product Status:

Last Time Buy

Sampling Rate (Per Second):

100k

Input Type:

Single Ended

Configuration:

S/H-ADC

Number of A/D Converters:

1

Reference Type:

External, Internal

Voltage - Supply, Digital:

5V

Operating Temperature:

-40°C ~ 85°C

Supplier Device Package:

20-SOIC

Base Product Number:

ADS7809

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

EAR99

**Burr-Brown Products**  
from Texas Instruments**ADS7809**

SBAS017C – NOVEMBER 1996 – REVISED OCTOBER 2006

# 16-Bit 10 $\mu$ s Serial CMOS Sampling ANALOG-TO-DIGITAL CONVERTER

## FEATURES

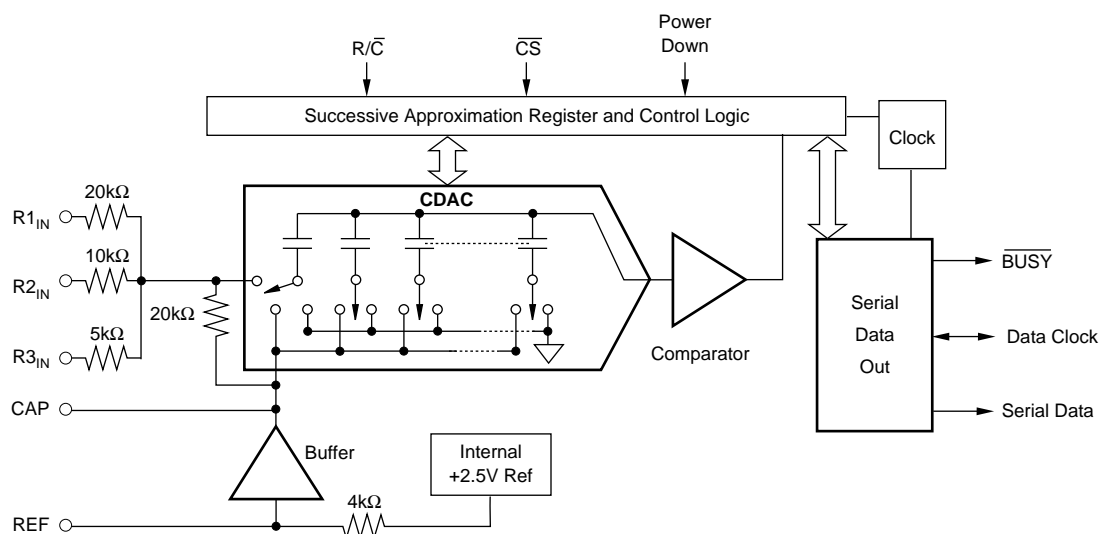
- 100kHz SAMPLING RATE
- 86dB SINAD WITH 20kHz INPUT
- $\pm 2$ LSB INL
- DNL: 16 Bits No Missing Codes
- SIX SPECIFIED INPUT RANGES
- SERIAL OUTPUT
- SINGLE +5V SUPPLY OPERATION
- PIN-COMPATIBLE WITH 12-BIT ADS7808
- USES INTERNAL OR EXTERNAL REFERENCE
- 100mW MAX POWER DISSIPATION
- 0.3" SO-20
- SIMPLE DSP INTERFACE

## DESCRIPTION

The ADS7809 is a complete 16-bit sampling Analog-to-Digital (A/D) converter using state-of-the-art CMOS structures. It contains a 16-bit capacitor-based Successive Approximation Register (SAR) A/D converter with sample-and-hold, reference, clock, and a serial data interface. Data can be outputted using the internal clock, or can be synchronized to an external data clock. The ADS7809 also provides an output synchronization pulse for ease of use with standard DSP processors.

The ADS7809 is specified at a 100kHz sampling rate, and specified over the full temperature range. Laser-trimmed scaling resistors provide various input ranges including  $\pm 10$ V and 0V to 5V, while an innovative design operates from a single +5V supply, with power dissipation under 100mW.

The ADS7809 is available in a 0.3" SO-20, and is fully specified for operation over the industrial  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  range.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

|   |   |
|---|---|
| Analog Inputs: R1 <sub>IN</sub> .....         | ±25V  |
| R2 <sub>IN</sub> .....                        | ±25V  |
| R3 <sub>IN</sub> .....                        | ±25V  |
| REF .....                                     | V <sub>ANA</sub> + 0.3V to AGND2 – 0.3V                           |
| CAP .....                                     | Indefinite Short to AGND2,<br>Momentary Short to V <sub>ANA</sub> |
| Ground Voltage Differences: DGND, AGND2 ..... | ±0.3V   |
| V <sub>ANA</sub> .....                        | 7V  |
| V <sub>DIG</sub> to V <sub>ANA</sub> .....    | +0.3  |
| V <sub>DIG</sub> .....                        | 7V  |
| Digital Inputs .....                          | –0.3V to V <sub>DIG</sub> + 0.3V                                  |
| Maximum Junction Temperature .....            | +165°C  |
| Internal Power Dissipation .....              | 700mW   |
| Lead Temperature (soldering, 10s) .....       | +300°C  |



**ELECTROSTATIC DISCHARGE SENSITIVITY**

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

NOTE: (1) Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.

**PACKAGE/ORDERING INFORMATION<sup>(1)</sup>**

| PRODUCT   | MAXIMUM LINEARITY ERROR (LSB) | NO MISSING CODE LEVEL (LSB) | MINIMUM SIGNAL-TO-(NOISE + DISTORTION) RATIO (dB) | PACKAGE-LEAD | PACKAGE DESIGNATOR | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER | TRANSPORT MEDIA, QUANTITY |
|-----------|-------------------------------|-----------------------------|---|--------------|--------------------|-----------------------------|-----------------|-----------------|---------------------------|
| ADS7809U  | ±3                            | 15                          | 83  | SO-20        | DW                 | –40°C to +85°C              | ADS7809U        | ADS7809U        | Rail, 38                  |
| "         | "                             | "                           | "   | "            | "                  | "                           | "               | ADS7809U/1K     | Tape and Reel, 1000       |
| ADS7809UB | ±2                            | 16                          | 86  | "            | "                  | "                           | ADS7809UB       | ADS7809UB       | Rail, 38                  |
| "         | "                             | "                           | "   | "            | "                  | "                           | "               | ADS7809UB/1K    | Tape and Reel, 1000       |

NOTE: (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

# ELECTRICAL CHARACTERISTICS

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $f_S = 100\text{kHz}$ ,  $V_{\text{DIG}} = V_{\text{ANA}} = +5\text{V}$ , using internal reference and fixed resistors (see Figure 4), unless otherwise specified.

| PARAMETER   | CONDITIONS   | ADS7809U       |                                      |   | ADS7809UB      |     |               | UNITS   |  |
|---|--|----------------|--------------------------------------|---|----------------|-----|---------------|---|--|
|   |  | MIN            | TYP                                  | MAX   | MIN            | TYP | MAX           |   |  |
| <b>RESOLUTION</b>   |  |                |                                      | 16  |                |     | *             | Bits  |  |
| <b>ANALOG INPUT</b><br>Voltage Ranges<br>Impedance<br>Capacitance   |  |                |                                      | ±10, 0V to 5V, etc. (See Table I)<br>See Table I      |                |     | *             | pF  |  |
| <b>THROUGHPUT SPEED</b><br>Complete Cycle<br>Throughput Rate  | Acquire and Convert  | 100            |                                      | 10  | *              |     | *             | μs<br>kHz   |  |
| <b>DC ACCURACY</b><br>Integral Linearity Error<br>Differential Linearity Error<br>No Missing Codes<br>Transition Noise <sup>(2)</sup><br>Full-Scale Error <sup>(3,4)</sup><br>Full-Scale Error Drift<br>Full-Scale Error <sup>(3,4)</sup><br>Full-Scale Error Drift<br>Bipolar Zero Error <sup>(3)</sup><br>Bipolar Zero Error Drift<br>Unipolar Zero Error <sup>(3)</sup><br>Unipolar Zero Error <sup>(3)</sup><br>Unipolar Zero Error Drift<br>Recovery to Rated Accuracy<br>after Power-Down<br>Power-Supply Sensitivity<br>( $V_{\text{DIG}} = V_{\text{ANA}} = V_{\text{D}}$ ) | Ext. 2.5000V Ref<br>Ext. 2.5000V Ref<br>Bipolar Ranges<br>Bipolar Ranges<br>0V to 10V Ranges<br>0V to 4V, 0V to 5V Ranges<br>Unipolar Ranges<br>1μF Capacitor to CAP<br><br>+4.75V < $V_{\text{D}}$ < +5.25V | 15             | 1.3<br>±7<br>±2<br>±2                | ±3<br>+3, -2<br>±0.5<br>±0.5<br>±10<br>±5<br>±3<br>±8 | 16             | *   | ±2<br>±1<br>* | LSB <sup>(1)</sup><br>LSB<br>Bits<br>LSB<br>%<br>ppm/°C<br>%<br>ppm/°C<br>mV<br>ppm/°C<br>mV<br>mV<br>ppm/°C<br>ms<br>LSB |  |
| <b>AC ACCURACY</b><br>Spurious-Free Dynamic Range<br>Total Harmonic Distortion<br>Signal-to-(Noise + Distortion)<br><br>Signal-to-Noise<br>Full-Power Bandwidth <sup>(6)</sup>  | $f_{\text{IN}} = 20\text{kHz}$<br>$f_{\text{IN}} = 20\text{kHz}$<br>$f_{\text{IN}} = 20\text{kHz}$<br>-60dB Input<br>$f_{\text{IN}} = 20\text{kHz}$  | 90<br>83<br>83 | 100<br>-100<br>88<br>30<br>88<br>250 | -90   | 96<br>86<br>86 | *   | *             | -94<br>*  | dB <sup>(5)</sup><br>dB<br>dB<br>dB<br>dB<br>kHz |
| <b>SAMPLING DYNAMICS</b><br>Aperture Delay<br>Transient Response<br>Overvoltage Recovery <sup>(7)</sup>   | FS Step  |                | 40<br>150                            | 2   |                | *   | *             | ns<br>μs<br>ns  |  |
| <b>REFERENCE</b><br>Internal Reference Voltage<br>Internal Reference Source Current<br>(Must use external buffer)<br>External Reference Voltage Range<br>For Specified Linearity<br>External Reference Current Drain  | No Load<br><br>Ext. 2.5000V Ref  | 2.48           | 2.5<br>1                             | 2.52  | *              | *   | *             | V<br>μA<br>V<br>μA  |  |
| <b>DIGITAL INPUTS</b><br>Logic Levels<br>$V_{\text{IL}}$<br>$V_{\text{IH}}^{(8)}$<br>$I_{\text{IL}}$<br>$I_{\text{IH}}$   | $V_{\text{IL}} = 0\text{V}$<br>$V_{\text{IH}} = 5\text{V}$   | -0.3<br>+2.0   |                                      | +0.8<br>$V_{\text{D}} + 0.3\text{V}$<br>±10<br>±10    | *              | *   | *             | V<br>V<br>μA<br>μA  |  |

# ELECTRICAL CHARACTERISTICS (Cont.)

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $f_S = 100\text{kHz}$ ,  $V_{\text{DIG}} = V_{\text{ANA}} = +5\text{V}$ , using internal reference and fixed resistors as shown in Figure 4, unless otherwise specified.

| PARAMETER   | CONDITIONS  | ADS7809U |     |         | ADS7809UB |     |     | UNITS                       |
|---|---|----------|-----|---------|-----------|-----|-----|-----------------------------|
|   |   | MIN      | TYP | MAX     | MIN       | TYP | MAX |                             |
| <b>DIGITAL OUTPUTS</b>                              |   |          |     |         |           |     |     |                             |
| Data Format   |   |          |     |         |           |     |     |                             |
| Data Co   |   |          |     |         |           |     |     |                             |
| Pipeline Delay                                      |   |          |     |         |           |     |     |                             |
| Data Clock  |   |          |     |         |           |     |     |                             |
| Internal<br>(Output Only When<br>Transmitting Data) | EXT/ $\overline{\text{INT}}$ LOW                                      |          | 2.3 |         |           | *   |     | MHz                         |
| External<br>(Can Run Continually)                   | EXT/ $\overline{\text{INT}}$ HIGH                                     | 0.1      |     | 10      | *         |     | *   | MHz                         |
| $V_{\text{OL}}$                                     | $I_{\text{SINK}} = 1.6\text{mA}$                                      |          |     | +0.4    |           |     | *   | V                           |
| $V_{\text{OH}}$                                     | $I_{\text{SOURCE}} = 500\mu\text{A}$                                  | +4       |     |         | *         |     | *   | V                           |
| Leakage Current                                     | High-Z State,<br>$V_{\text{OUT}} = 0\text{V}$ to $V_{\text{DIG}}$     |          |     | $\pm 5$ |           |     | *   | $\mu\text{A}$               |
| Output Capacitance                                  | High-Z State  |          |     | 15      |           |     | *   | pF                          |
| <b>POWER SUPPLIES</b>                               |   |          |     |         |           |     |     |                             |
| Specified Performance                               | Must be $\leq V_{\text{ANA}}$   | +4.75    | +5  | +5.25   | *         | *   | *   | V                           |
| $V_{\text{DIG}}$                                    |   | +4.75    | +5  | +5.25   | *         | *   | *   | V                           |
| $V_{\text{ANA}}$                                    |   |          | 0.3 |         |           | *   |     | mA                          |
| $I_{\text{DIG}}$                                    |   |          | 16  |         |           | *   |     | mA                          |
| $I_{\text{ANA}}$                                    |   |          |     | 100     |           | *   | *   | mW                          |
| Power Dissipation: PWRD LOW                         | $V_{\text{ANA}} = V_{\text{DIG}} = 5\text{V}$ , $f_S = 100\text{kHz}$ |          |     |         |           | *   | *   | mW                          |
| Power Dissipation: PWRD HIGH                        |   |          | 50  |         |           | *   | *   | $\mu\text{W}$               |
| <b>TEMPERATURE RANGE</b>                            |   |          |     |         |           |     |     |                             |
| Specified Performance                               |   | -40      |     | +85     | *         |     | *   | $^{\circ}\text{C}$          |
| Derated Performance                                 |   | -55      |     | +125    | *         |     | *   | $^{\circ}\text{C}$          |
| Storage   |   | -65      |     | +150    | *         |     | *   | $^{\circ}\text{C}$          |
| Thermal Resistance ( $\theta_{\text{JA}}$ )         |   |          |     |         |           |     |     | $^{\circ}\text{C}/\text{W}$ |
| SO  |   |          | 75  |         |           | *   |     |                             |

\* Same as specification for ADS7809U.

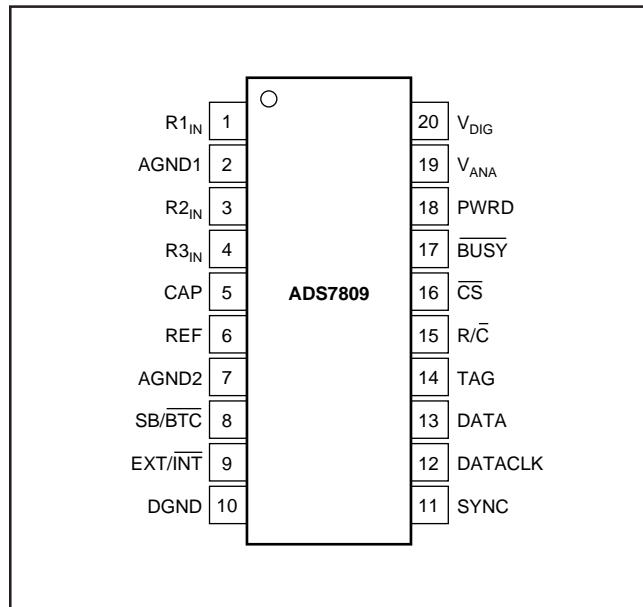
NOTES: (1) LSB means Least Significant Bit. For the  $\pm 10\text{V}$  input range, one LSB is  $305\mu\text{V}$ .

- (2) Typical rms noise at worst case transitions and temperatures.
- (3) As measured with fixed resistors shown in Figure 4. Adjustable to zero with external potentiometer.
- (4) For bipolar input ranges, full-scale error is the worst case of -Full Scale or +Full Scale untrimmed deviation from ideal first and last code transitions, divided by the transition voltage (not divided by the full-scale range) and includes the effect of offset error. For unipolar input ranges, full-scale error is the deviation of the last code transition divided by the transition voltage. It also includes the effect of offset error.
- (5) All specifications in dB are referred to a full-scale  $\pm 10\text{V}$  input.
- (6) Full-Power Bandwidth defined as Full-Scale input frequency at which Signal-to-(Noise + Distortion) degrades to 60dB.
- (7) Recovers to specified performance after  $2 \cdot \text{FS}$  input overvoltage.
- (8) The minimum  $V_{\text{IH}}$  level for the DATACLK signal is 3V.

**PIN ASSIGNMENTS**

| PIN # | NAME             | DESCRIPTION  |
|-------|------------------|--|
| 1     | R1 <sub>IN</sub> | Analog Input. See Table I and Figure 4 for input range connections.  |
| 2     | AGND1            | Analog Ground. Used internally as ground reference point. Minimal current flow.  |
| 3     | R2 <sub>IN</sub> | Analog Input. See Table I and Figure 4 for input range connections.  |
| 4     | R3 <sub>IN</sub> | Analog Input. See Table I and Figure 4 for input range connections.  |
| 5     | CAP              | Reference Buffer Capacitor. 2.2μF Tantalum to ground.  |
| 6     | REF              | Reference Input/Output. Outputs internal 2.5V reference. Can also be driven by external system reference. In both cases, bypass to ground with a 2.2μF Tantalum capacitor.   |
| 7     | AGND2            | Analog Ground  |
| 8     | SB/BTC           | Select Straight Binary or Binary Two's Complement data output format. If HIGH, data will be output in a Straight Binary format. If LOW, data will be output in a Binary Two's Complement format.   |
| 9     | EXT/INT          | Select External or Internal Clock for transmitting data. If HIGH, data will be output synchronized to the clock input on DATACLK. If LOW, a convert command will initiate the transmission of the data from the previous conversion, along with 16 clock pulses output on DATACLK.   |
| 10    | DGND             | Digital Ground   |
| 11    | SYNC             | Synch Output. If EXT/INT is HIGH, either a rising edge on R/C with CS LOW or a falling edge on CS with R/C HIGH will output a pulse on SYNC synchronized to the external DATACLK.  |
| 12    | DATACLK          | Either an input or an output depending on the EXT/INT level. Output data will be synchronized to this clock. If EXT/INT is LOW, DATACLK will transmit 16 pulses after each conversion, and then remain LOW between conversions.  |
| 13    | DATA             | Serial Data Output. Data will be synchronized to DATACLK, with the format determined by the level of SB/BTC. In the external clock mode, after 16 bits of data, the ADS7809 will output the level input on TAG as long as CS is LOW and R/C is HIGH (see Figure 3). If EXT/INT is LOW, data will be valid on both the rising and falling edges of DATACLK, and between conversions DATA will stay at the level of the TAG input when the conversion was started. |
| 14    | TAG              | Tag Input for use in external clock mode. If EXT/INT is HIGH, digital data input on TAG will be output on DATA with a delay of 16 DATACLK pulses as long as CS is LOW and R/C is HIGH. See Figure 3.   |
| 15    | R/C              | Read/Convert Input. With CS LOW, a falling edge on R/C puts the internal sample-and-hold into the hold state and starts a conversion. When EXT/INT is LOW, this also initiates the transmission of the data results from the previous conversion. If EXT/INT is HIGH, a rising edge on R/C with CS LOW, or a falling edge on CS with R/C HIGH, transmits a pulse on SYNC and initiates the transmission of data from the previous conversion.                    |
| 16    | CS               | Chip Select. Internally OR'ed with R/C.  |
| 17    | BUSY             | Busy Output. Falls when a conversion is started, and remains LOW until the conversion is completed and the data is latched into the output shift register. CS or R/C must be HIGH when BUSY rises, or another conversion will start without time for signal acquisition.   |
| 18    | PWRD             | Power Down Input. If HIGH, conversions are inhibited and power consumption is significantly reduced. Results from the previous conversion are maintained in the output shift register.   |
| 19    | V <sub>ANA</sub> | Analog Supply Input. Nominally +5V. Connect directly to pin 20, and decouple to ground with 0.1μF ceramic and 10μF tantalum capacitors.  |
| 20    | V <sub>DIG</sub> | Digital Supply Input. Nominally +5V. Connect directly to pin 19. Must be ≤ V <sub>ANA</sub> .  |

**PIN CONFIGURATION**



| ANALOG INPUT RANGE | CONNECT R1 <sub>IN</sub> VIA 200Ω TO | CONNECT R2 <sub>IN</sub> VIA 100Ω TO | CONNECT R3 <sub>IN</sub> TO | IMPEDANCE |
|--------------------|--------------------------------------|--------------------------------------|-----------------------------|-----------|
| ±10V               | V <sub>IN</sub>                      | AGND                                 | CAP                         | 22.9kΩ    |
| ±5V                | AGND                                 | V <sub>IN</sub>                      | CAP                         | 13.3kΩ    |
| ±3.33V             | V <sub>IN</sub>                      | V <sub>IN</sub>                      | CAP                         | 10.7kΩ    |
| 0V to 10V          | AGND                                 | V <sub>IN</sub>                      | AGND                        | 13.3kΩ    |
| 0V to 5V           | AGND                                 | AGND                                 | V <sub>IN</sub>             | 10.0kΩ    |
| 0V to 4V           | V <sub>IN</sub>                      | AGND                                 | V <sub>IN</sub>             | 10.7kΩ    |

TABLE I. Input Range Connections. See Figure 4 for complete information.

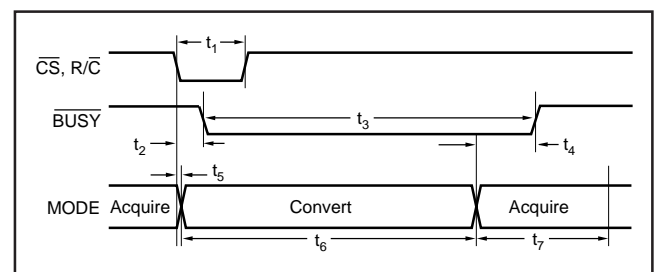


FIGURE 1. Basic Conversion Timing.

| SYMBOL      | DESCRIPTION   | MIN | TYP | MAX          | UNITS         |
|-------------|---|-----|-----|--------------|---------------|
| $t_1$       | Convert Pulse Width   | 40  |     | 6000         | ns            |
| $t_2$       | $\overline{\text{BUSY}}$ Delay                                      |     |     | 65           | ns            |
| $t_3$       | $\overline{\text{BUSY}}$ LOW  |     |     | 8            | $\mu\text{s}$ |
| $t_4$       | $\overline{\text{BUSY}}$ Delay After End of Conversion              |     | 220 |              | ns            |
| $t_5$       | Aperture Delay  |     | 40  |              | ns            |
| $t_6$       | Conversion Time   |     | 7.6 | 8            | $\mu\text{s}$ |
| $t_7$       | Acquisition Time  |     |     | 2            | $\mu\text{s}$ |
| $t_6 + t_7$ | Throughput Time   |     | 9   | 10           | $\mu\text{s}$ |
| $t_8$       | $\text{R}/\overline{\text{C}}$ LOW to DATACLK Delay                 |     | 450 |              | ns            |
| $t_9$       | DATACLK Period  |     | 440 |              | ns            |
| $t_{10}$    | Data Valid to DATACLK HIGH Delay                                    | 20  | 75  |              | ns            |
| $t_{11}$    | Data Valid After DATACLK LOW Delay                                  | 100 | 125 |              | ns            |
| $t_{12}$    | External DATACLK  | 100 |     |              | ns            |
| $t_{13}$    | External DATACLK HIGH   | 20  |     |              | ns            |
| $t_{14}$    | External DATACLK LOW  | 30  |     |              | ns            |
| $t_{15}$    | DATACLK HIGH Setup Time   | 20  |     | $t_{12} + 5$ | ns            |
| $t_{16}$    | $\text{R}/\overline{\text{C}}$ to $\overline{\text{CS}}$ Setup Time | 10  |     |              | ns            |
| $t_{17}$    | SYNC Delay After DATACLK HIGH                                       | 15  |     | 35           | ns            |
| $t_{18}$    | Data Valid Delay  | 25  |     | 55           | ns            |
| $t_{19}$    | $\overline{\text{CS}}$ to Rising Edge Delay                         | 25  |     |              | ns            |
| $t_{20}$    | Data Available after $\overline{\text{CS}}$ LOW                     | 6   |     |              | $\mu\text{s}$ |

TABLE II. Conversion and Data Timing.  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ .

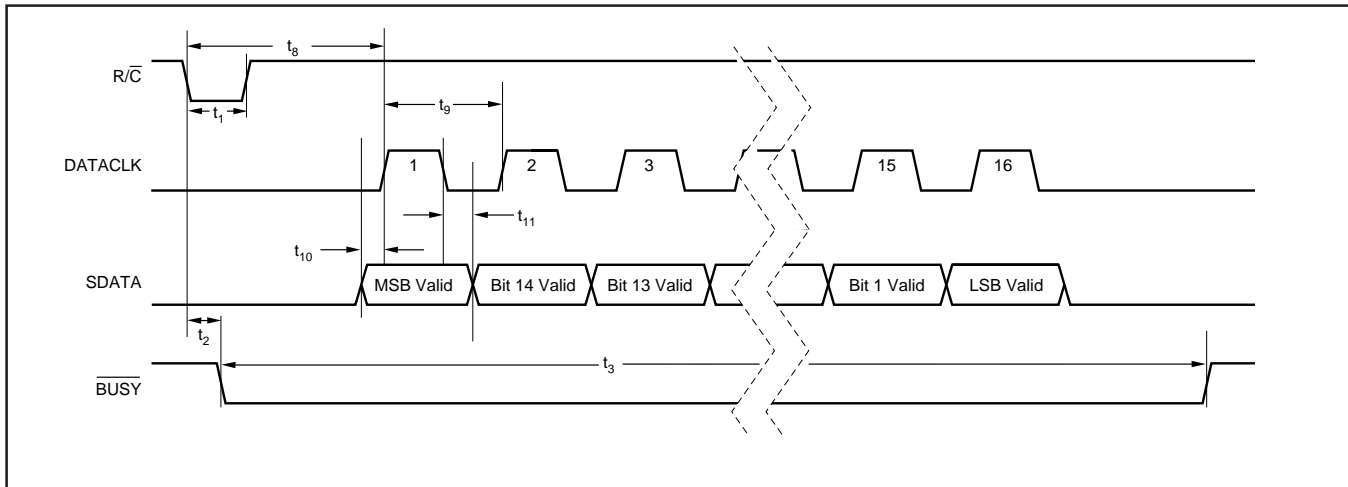


FIGURE 2. Serial Data Timing Using Internal Clock. ( $\overline{\text{CS}}$ ,  $\text{EXT}/\overline{\text{INT}}$  and TAG Tied LOW.)

| SPECIFIC FUNCTION  | $\overline{CS}$ | $R/\overline{C}$ | $\overline{BUSY}$ | $\overline{EXT}/\overline{INT}$ | DATACLK | PWRD | SB/ $\overline{BTC}$ | OPERATION  |
|--|-----------------|------------------|-------------------|---------------------------------|---------|------|----------------------|--|
| Initiate Conversion and Output Data Using Internal Clock | 1 > 0           | 0                | 1                 | 0                               | Output  | 0    | x                    | Initiates conversion "n". Data from conversion "n - 1" clocked out on DATA synchronized to 16 clock pulses output on DATACLK.                            |
|  | 0               | 1 > 0            | 1                 | 0                               | Output  | 0    | x                    | Initiates conversion "n". Data from conversion "n - 1" clocked out on DATA synchronized to 16 clock pulses output on DATACLK.                            |
| Initiate Conversion and Output Data Using External Clock | 1 > 0           | 0                | 1                 | 1                               | Input   | 0    | x                    | Initiates conversion "n".  |
|  | 0               | 1 > 0            | 1                 | 1                               | Input   | 0    | x                    | Initiates conversion "n".  |
|  | 1 > 0           | 1                | 1                 | 1                               | Input   | x    | x                    | Outputs a pulse on SYNC followed by data from conversion "n" clocked out synchronized to external DATACLK.   |
|  | 1 > 0           | 1                | 0                 | 1                               | Input   | 0    | x                    | Outputs a pulse on SYNC followed by data from conversion "n - 1" clocked out synchronized to external DATACLK. <sup>(1)</sup> Conversion "n" in process. |
| Incorrect Conversions                                    | 0               | 0                | 0 > 1             | x                               | x       | 0    | x                    | $\overline{CS}$ or $R/\overline{C}$ must be HIGH or a new conversion will be initiated without time for acquisition.                                     |
|  | x               | x                | x                 | x                               | x       | 0    | x                    | Analog circuitry powered. Conversion can proceed.  |
| Power-Down   | x               | x                | x                 | x                               | x       | 1    | x                    | Analog circuitry disabled. Data from previous conversion maintained in output registers.   |
|  | x               | x                | x                 | x                               | x       | x    | 0                    |  |
| Selecting Output Format                                  | x               | x                | x                 | x                               | x       | x    | 0                    | Serial data is output in Binary Two's Complement format.   |
|  | x               | x                | x                 | x                               | x       | x    | 1                    | Serial data is output in Straight Binary format.   |

NOTE: (1) See Figure 3b for constraints on previous data valid during conversion.

TABLE III. Control Truth Table.

| DESCRIPTION                 | ANALOG INPUT |              |              |             |            |            | DIGITAL OUTPUT                                     |          |   |          |
|-----------------------------|--------------|--------------|--------------|-------------|------------|------------|--|----------|---|----------|
|                             |              |              |              |             |            |            | BINARY TWO'S COMPLEMENT (SB/ $\overline{BTC}$ LOW) |          | STRAIGHT BINARY (SB/ $\overline{BTC}$ HIGH) |          |
|                             |              |              |              |             |            |            | BINARY CODE  | HEX CODE | BINARY CODE                                 | HEX CODE |
| Full-Scale Range            | $\pm 10$     | $\pm 5$      | $\pm 3.33V$  | 0V to 10V   | 0V to 5V   | 0V to 4V   |  |          |   |          |
| Least Significant Bit (LSB) | 305 $\mu V$  | 153 $\mu V$  | 102 $\mu V$  | 153 $\mu V$ | 76 $\mu V$ | 61 $\mu V$ |  |          |   |          |
| +Full Scale (FS - 1LSB)     | 9.999695V    | 4.999847V    | 3.333231V    | 9.999847V   | 4.999924V  | 3.999939V  | 0111 1111 1111 1111                                | 7FFF     | 1111 1111 1111 1111                         | FFFF     |
| Midscale                    | 0V           | 0V           | 0V           | 5V          | 2.5V       | 2V         | 0000 0000 0000 0000                                | 0000     | 1000 0000 0000 0000                         | 8000     |
| One LSB Below Midscale      | -305 $\mu V$ | -153 $\mu V$ | -102 $\mu V$ | 4.999847V   | 2.499924V  | 1.999939V  | 1111 1111 1111 1111                                | FFFF     | 0111 1111 1111 1111                         | 7FFF     |
| -Full Scale                 | -10V         | -5V          | -3.333333V   | 0V          | 0V         | 0V         | 1000 0000 0000 0000                                | 8000     | 0000 0000 0000 0000                         | 0000     |

TABLE IV. Output Codes and Ideal Input Voltages.

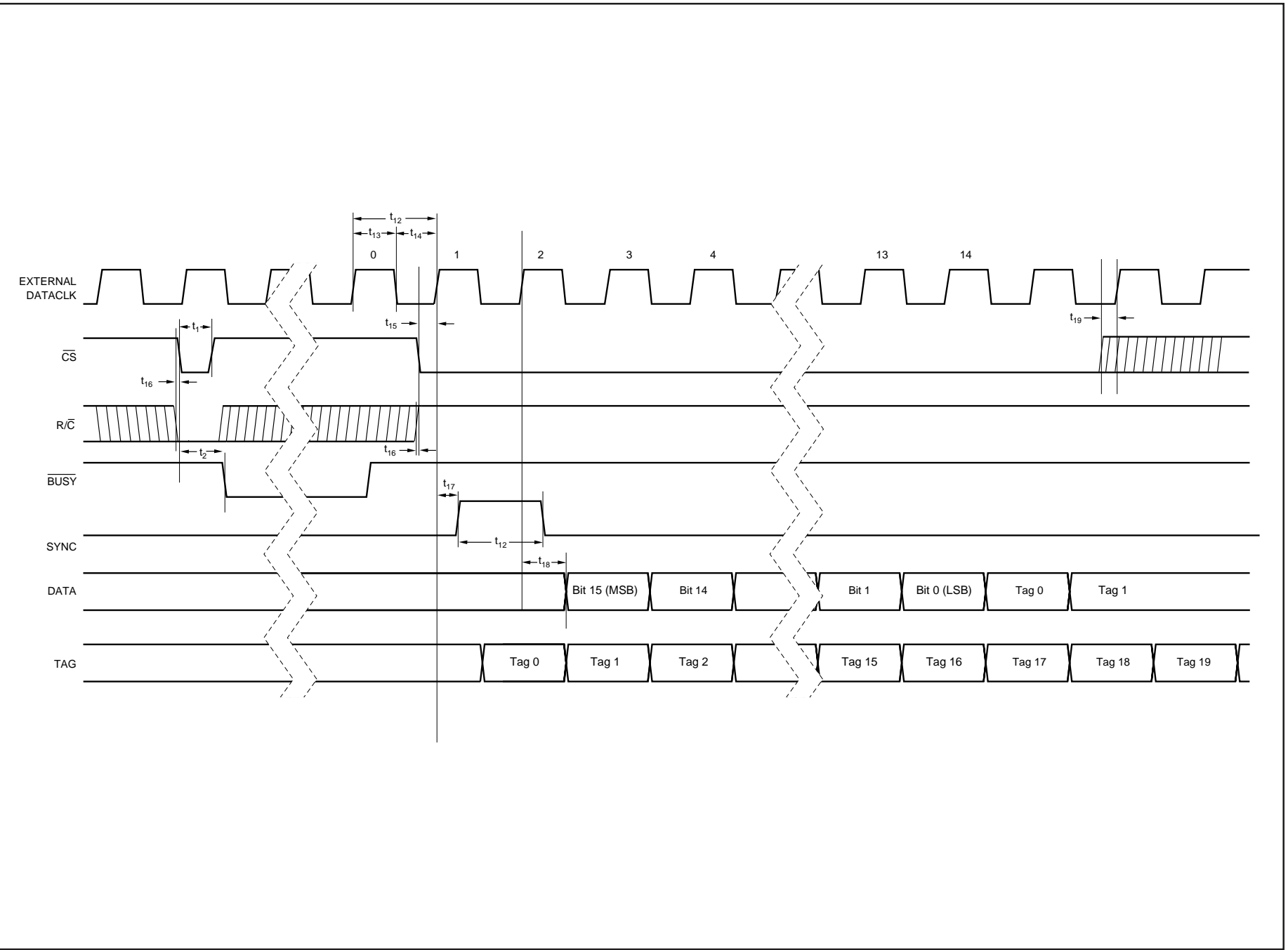


FIGURE 3a. Conversion and Read Timing with External Clock. (EXT/INT Tied High.) Read After Conversion.

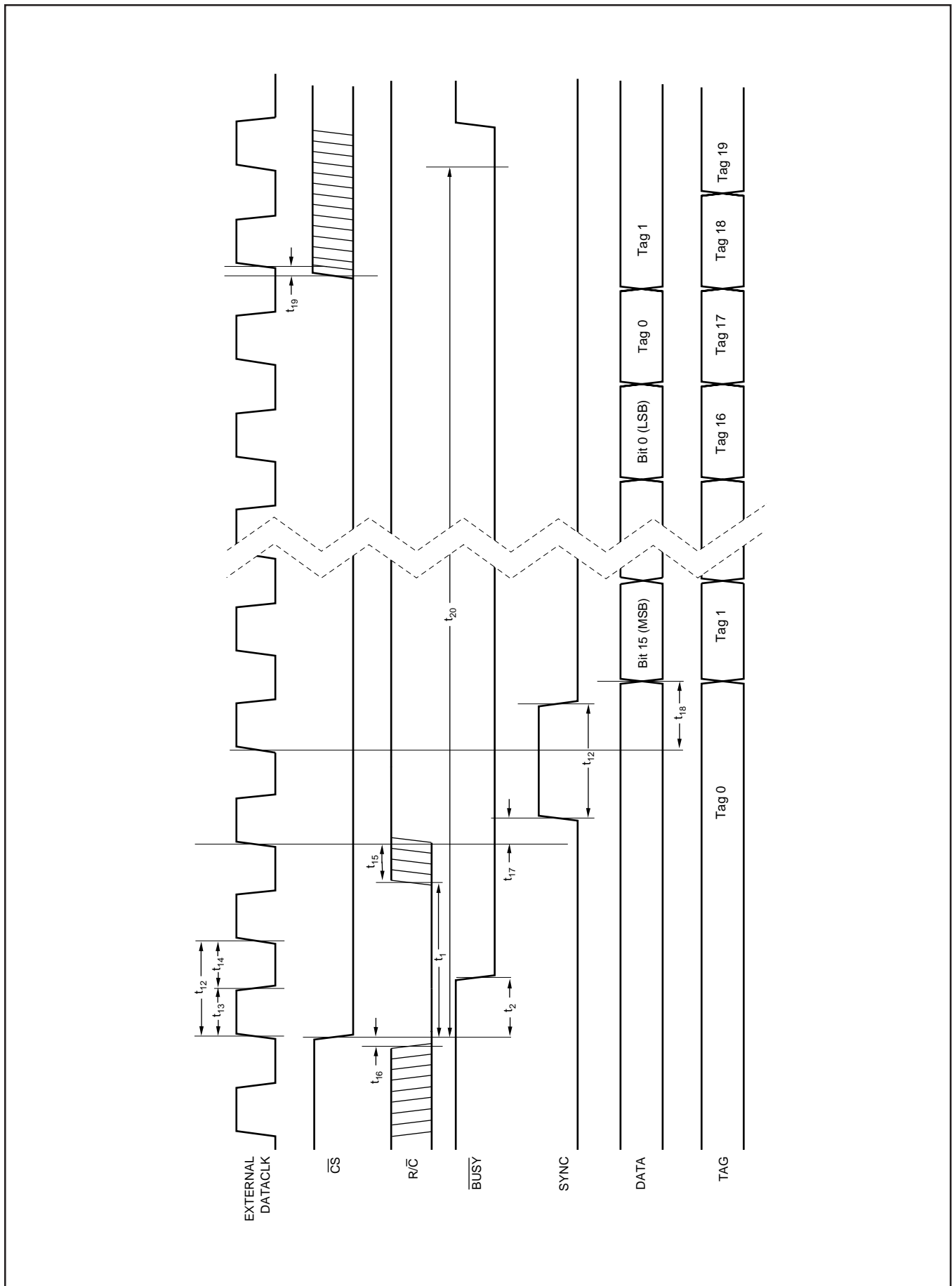


FIGURE 3b. Conversion and Read Timing with External Clock. (EXT/INT Tied High.) Read During Conversion (Previous Conversion Results).

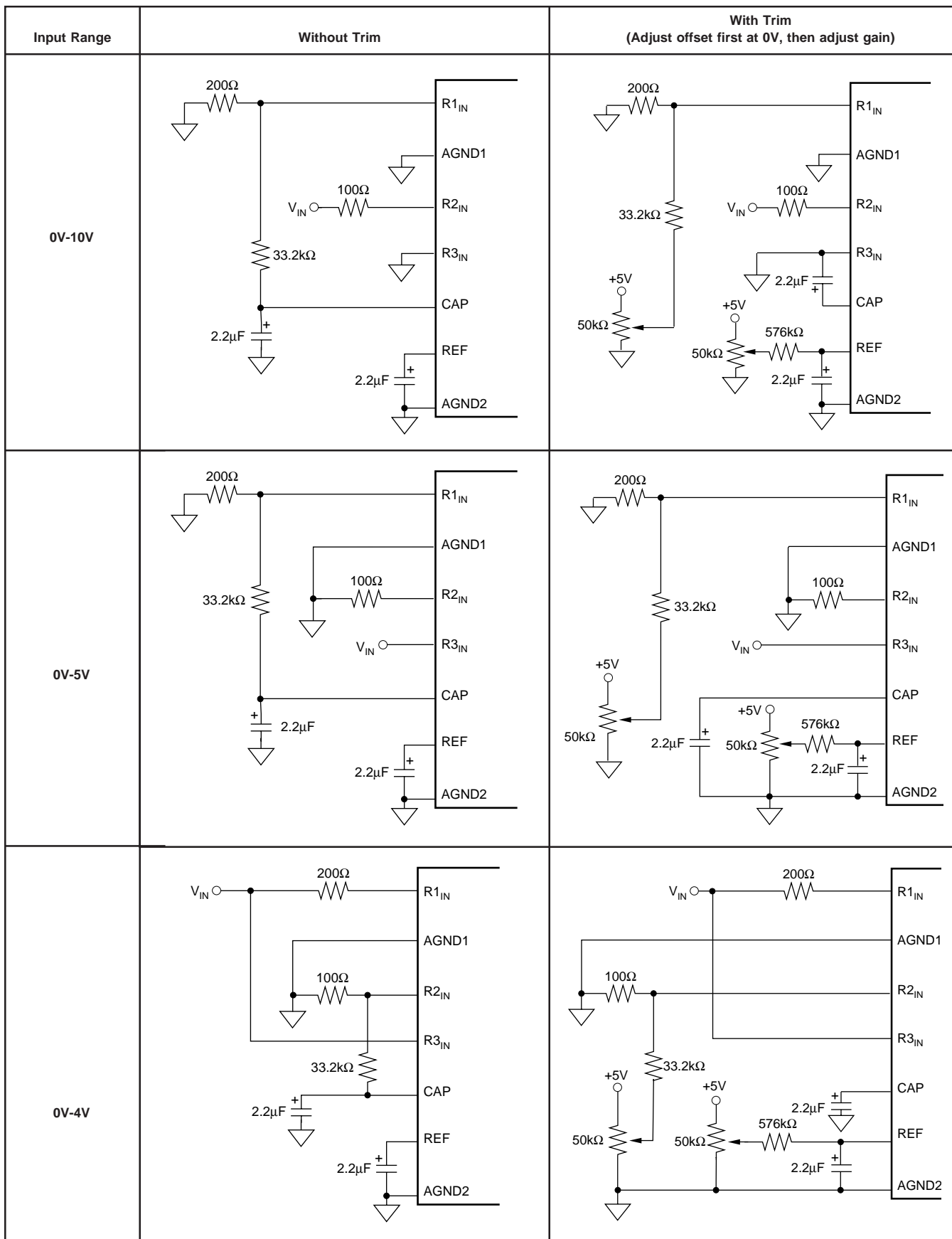


FIGURE 4a. Offset/Gain Circuits for Unipolar Input Ranges.

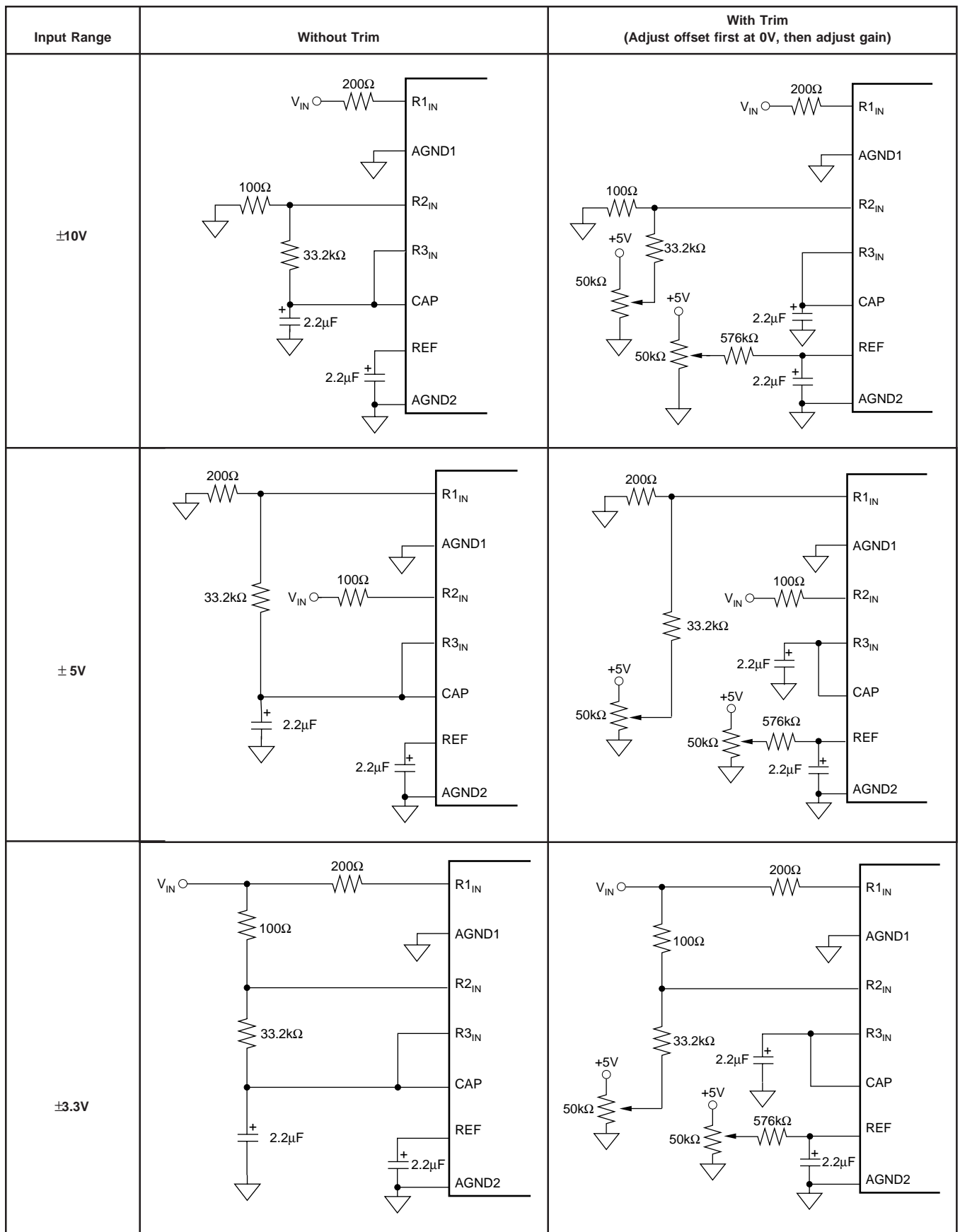


FIGURE 4b. Offset/Gain Circuits for Bipolar Input Ranges.

## Revision History

| DATE  | REVISION | PAGE | SECTION                  | DESCRIPTION                |
|-------|----------|------|--------------------------|----------------------------|
| 10/06 | C        | 3    | Absolute Maximum Ratings | CAP and REF were switched. |

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

**PACKAGING INFORMATION**

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">ADS7809U</a>     | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| ADS7809U.A                   | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| <a href="#">ADS7809U/1K</a>  | Active        | Production           | SOIC (DW)   20 | 1000   LARGE T&R      | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| ADS7809U/1K.A                | Active        | Production           | SOIC (DW)   20 | 1000   LARGE T&R      | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| ADS7809U/1KE4                | Active        | Production           | SOIC (DW)   20 | 1000   LARGE T&R      | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| <a href="#">ADS7809UB</a>    | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| ADS7809UB.A                  | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| <a href="#">ADS7809UB/1K</a> | Active        | Production           | SOIC (DW)   20 | 1000   LARGE T&R      | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| ADS7809UB/1K.A               | Active        | Production           | SOIC (DW)   20 | 1000   LARGE T&R      | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |
| ADS7809UE4                   | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 85    | ADS7809U            |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

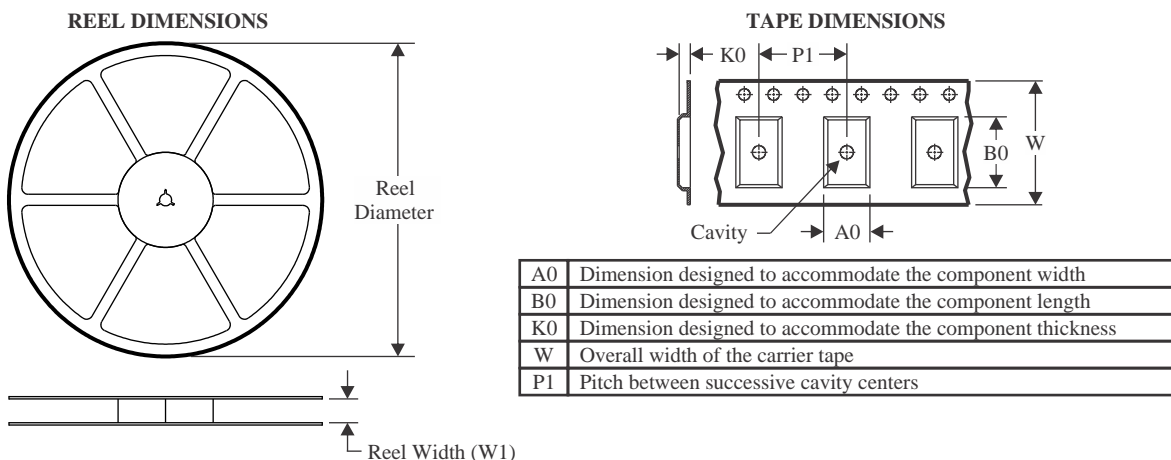
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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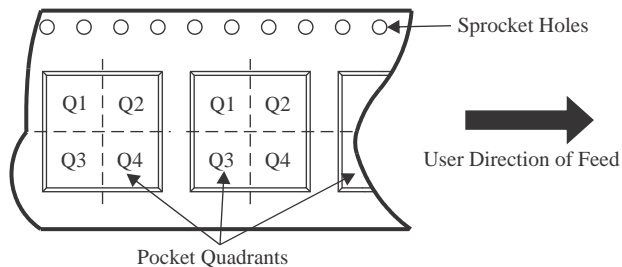
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## TAPE AND REEL INFORMATION



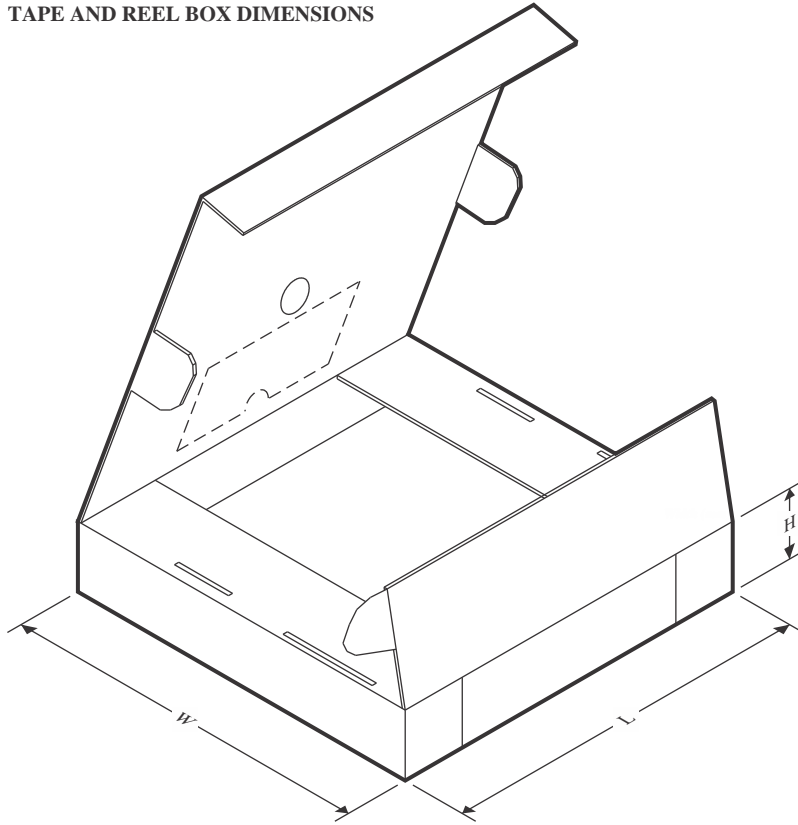
### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS7809U/1K  | SOIC         | DW              | 20   | 1000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| ADS7809UB/1K | SOIC         | DW              | 20   | 1000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

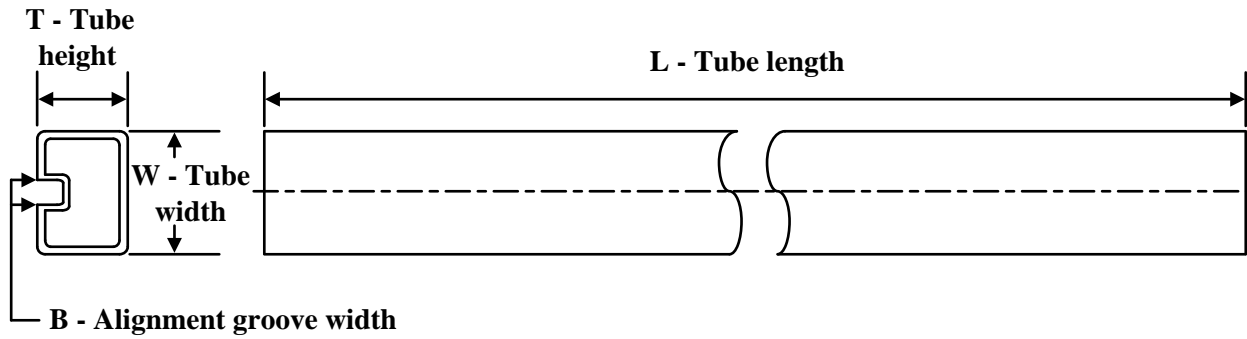
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS7809U/1K  | SOIC         | DW              | 20   | 1000 | 356.0       | 356.0      | 45.0        |
| ADS7809UB/1K | SOIC         | DW              | 20   | 1000 | 356.0       | 356.0      | 45.0        |

## TUBE



\*All dimensions are nominal

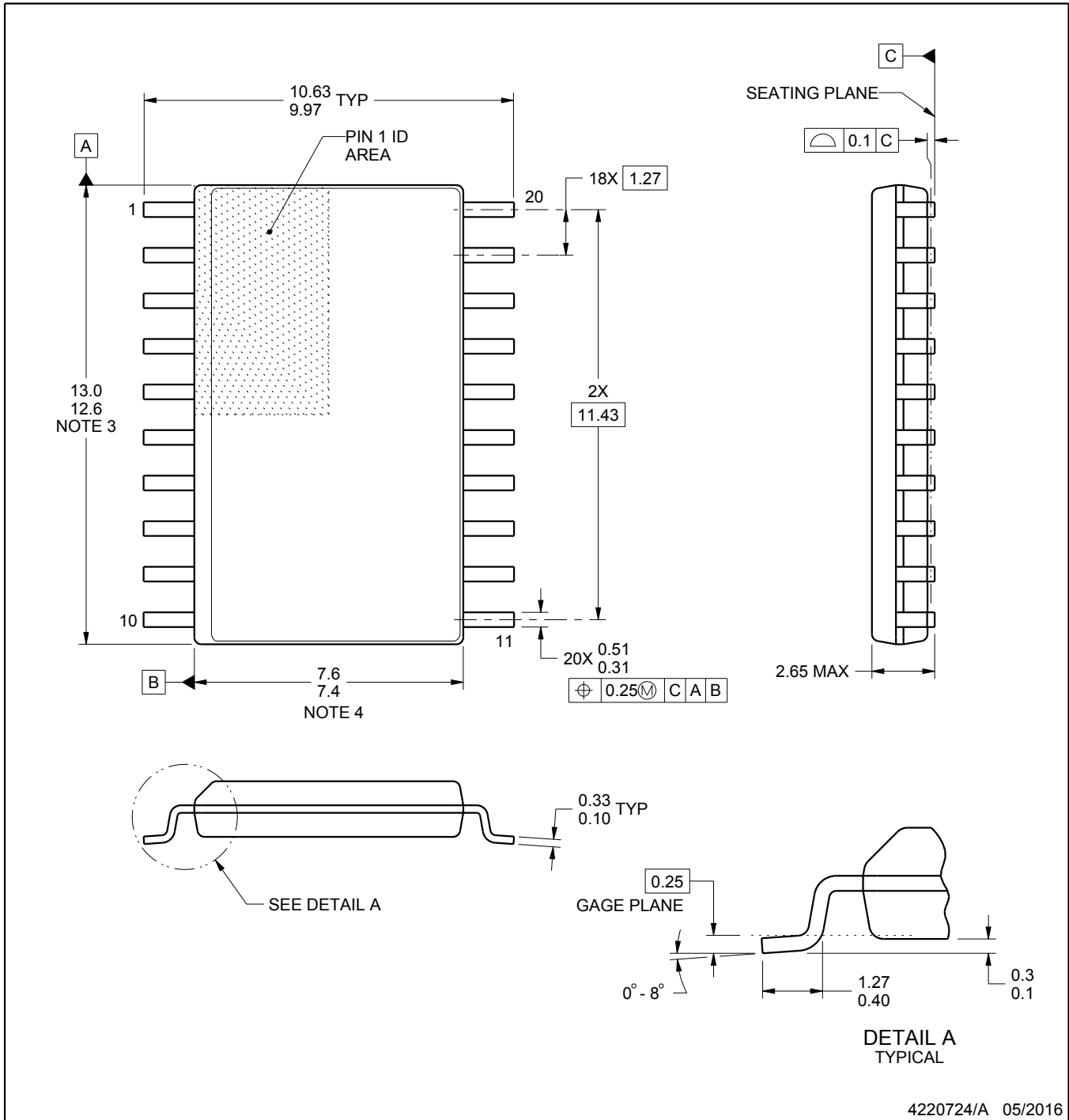
| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| ADS7809U    | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| ADS7809U.A  | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| ADS7809UB   | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| ADS7809UB.A | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| ADS7809UE4  | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |



DW0020A

PACKAGE OUTLINE  
SOIC - 2.65 mm max height

SOIC



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NOTES:

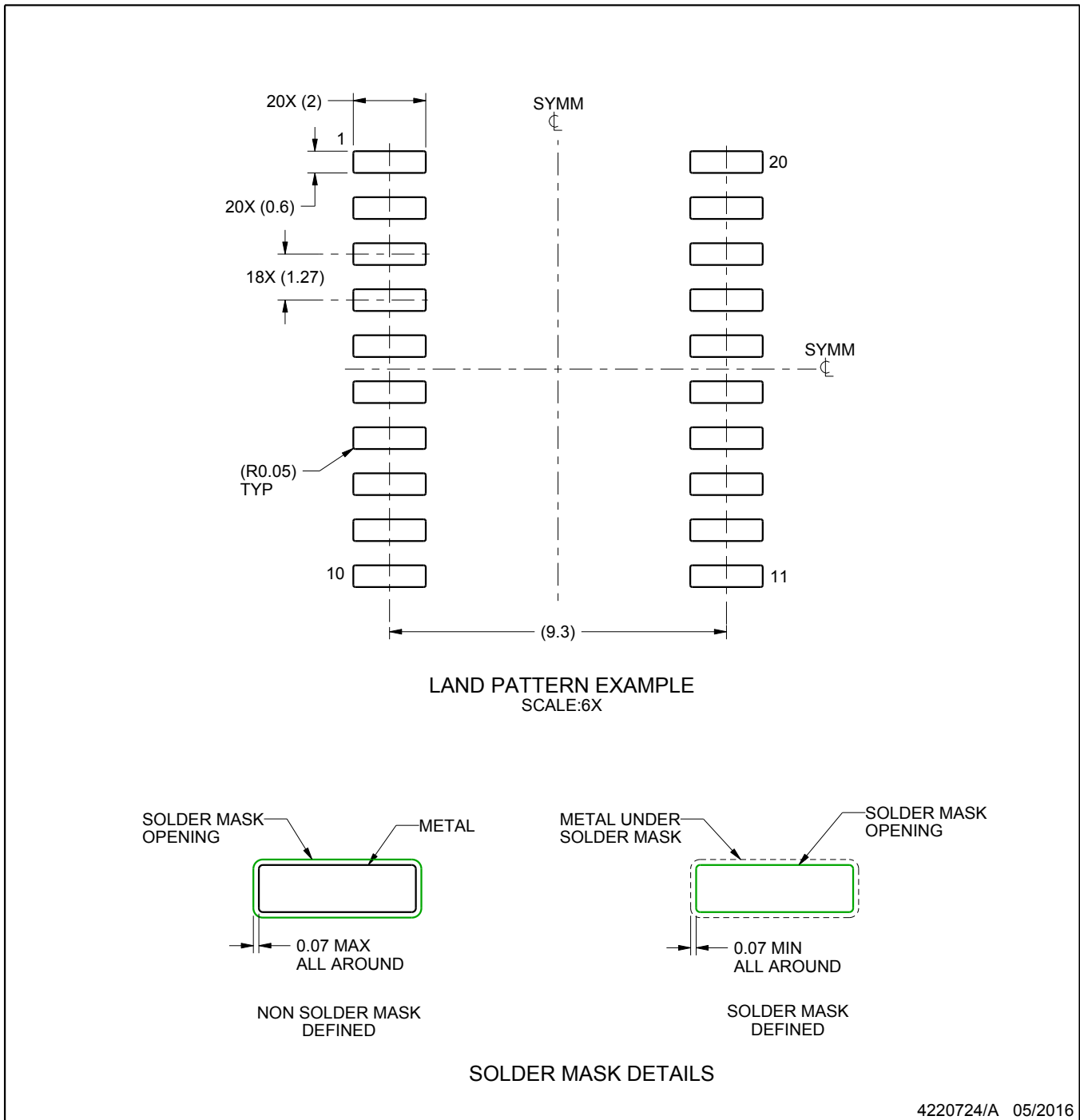
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

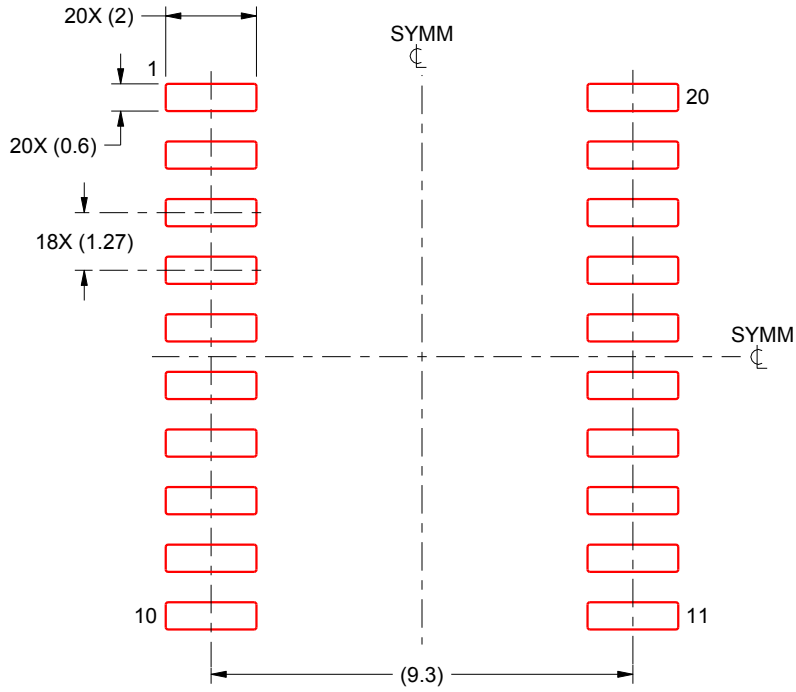
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
 BASED ON 0.125 mm THICK STENCIL  
 SCALE:6X

4220724/A 05/2016

NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

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